



#### **4A STANDARD RECOVERY BRIDGE RECTIFIER**

#### **Product Summary**

V <sub>RRM</sub> (V)	I <sub>F</sub> (A)	V <sub>F</sub> Max (V) @ I <sub>F</sub> = 2.0A	I <sub>R</sub> Max (μA)
600, 800, 1000	4	1.0	5

## **Mechanical Data**

- Case: GBP
- Case Material: plastic material, UL flammability classification 94V-0.(No Br. Sb, Cl)
- Terminals: Finish Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208 (2)
- Polarity indicator: symbol molded on body.
- Weight: 1.33 grams (Approximate)



# Features

- Glass Passivated Die Construction
- Rating to 1000V PRV
- Ideal for printed circuit board
- Reliable construction utilizing molded plastic
- UL recognized file # E94661
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please <u>contact us</u> or your local Diodes representative. <a href="https://www.diodes.com/quality/product-definitions/">https://www.diodes.com/quality/product-definitions/</a>



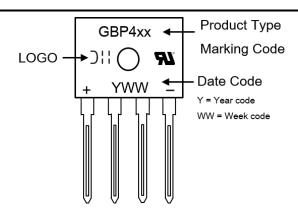
# **Ordering Information** (Note 4)

Part Number	Qualification	Case	Packaging
GBP406	Commercial	GBP	35/Tube
GBP408	Commercial	GBP	35/Tube
GBP410	Commercial	GBP	35/Tube

Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

#### **Marking Information**





## Maximum Ratings (@ T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	GBP406	GBP408	GBP410	Unit
Maximum repetitive peak reverse voltage	$V_{RRM}$	600	800	1000	V
Maximum DC blocking voltage	V <sub>DC</sub>	600	800	1000	V
Maximum average rectified output current with heatsink $@T_C = +90^{\circ}C$ without heatsink	I <sub>F(AV)</sub>		4.0 2.1	•	Α
Peak forward surge current 8.3ms single half sine wave $T_J = +25^{\circ}C$ superimposed on rated load. $T_J = +125^{\circ}C$	I <sub>FSM</sub>		135 120		А
Peak forward surge current 1.0ms single half sine wave $T_J = +25^{\circ}C$ superimposed on rated load. $T_J = +125^{\circ}C$	I <sub>FSM</sub>	330 300		А	
I <sup>2</sup> t rating for fusing (t = 8.3ms)	I <sup>2</sup> t	75		A <sup>2</sup> S	
Operating temperature range	TJ	-55 to + 150		°C	
Storage temperature range	T <sub>STG</sub>	-55 to + 150		°C	

## **Electrical Characteristics**

Characteristic	Test C	onditions	Symbol	Max	Unit
Forward voltage	I <sub>F</sub> = 2.0A	$T_J = +25^{\circ}C$	V <sub>F</sub>	1.0	V
Leakage current	V <sub>R</sub> at Rated	$T_{J} = +25^{\circ}C$ $T_{J} = +125^{\circ}C$	I <sub>R</sub>	5 500	μA
Typical junction capacitance (Note 5)			CJ	40	₽F

# Thermal Characteristics

Characteristic	Symbol	Тур.	Unit
Typical thermal resistance (Note 6)	RthJ <sub>C</sub>	7.5	°C/W

Notes:

<sup>5.</sup> Measured at  $1.0 MH_Z$  and applied reverse voltage of 4.0 V DC.
6. Thermal resistance junction to case. Device mounted on  $50 mm \times 50 mm \times 2 mm$  Cu plate heatsink.



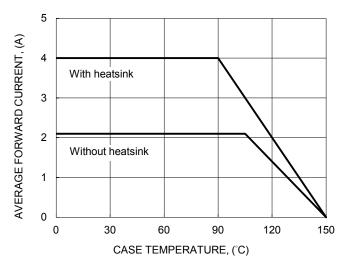


Figure 1. Forward Current Derating Curve

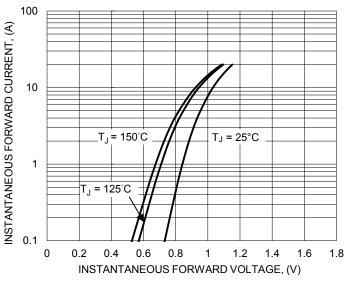


Figure 3. Typical Forward Characteristics

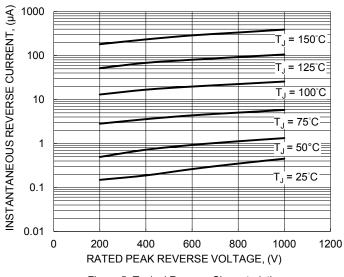


Figure 5. Typical Reverse Characteristics

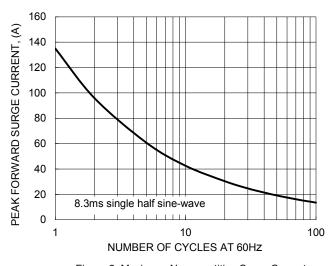


Figure 2. Maximum Non-repetitive Surge Current

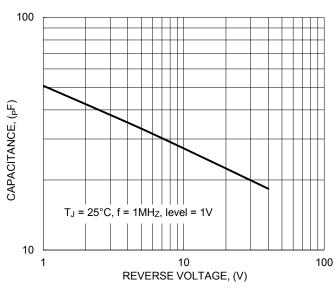


Figure 4. Typcial Junction Capacitance

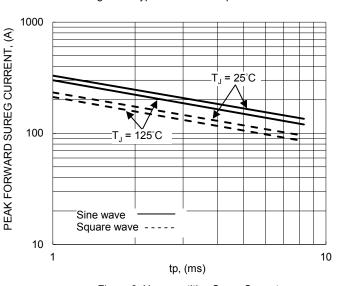
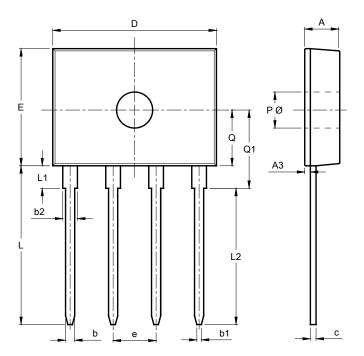


Figure 6. Non-repetitive Surge Current



# **Package Outline Dimensions**

 $Please\ see\ http://www.diodes.com/package-outlines.html\ for\ the\ latest\ version.$ 



GBP					
Dim	Min	Min Max T			
Α	2.90	3.30	3.10		
A3	0.30	0.70	0.50		
b	0.76	0.86	0.81		
b1	0.35	0.45	0.40		
b2	1.20	1.40	1.30		
С	0.40	0.60	0.50		
D	14.20	14.70	14.50		
E	10.10	10.70	10.40		
е	3.71	3.91	3.81		
L	13.80	14.40	14.10		
L1	1.80	2.20	2.00		
L2	12.10 REF				
PØ	3.20 REF				
Q	4.65	5.25	4.95		
Q1	6.65	7.25	6.95		
All Dimensions in mm					



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